

# PRELIMINARY

Note: This is not a final specification.  
Some parametric limits are subject to change.

MITSUBISHI SEMICONDUCTOR <GaAs FET>

# MGFC42V4450A

## 4.4~5.0GHz BAND 16W INTERNALLY MATCHED GaAs FET

### DESCRIPTION

The MGFC42V4450A is an internally impedance-matched GaAs power FET especially designed for use in 4.4~5.0 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

### FEATURES

- Class A operation
- Internally matched to  $50\Omega$  system
- High output power  
 $P_{1dB} = 18\text{ W (TYP)} @ 4.4\text{~}5.0\text{ GHz}$
- High power gain  
 $G_{LP} = 9\text{ dB (TYP)} @ 4.4\text{~}5.0\text{ GHz}$
- High power added efficiency  
 $\eta_{add} = 33\%(\text{TYP}) @ 4.4\text{~}5.0\text{ GHz}, P_{1dB}$
- Hermetically sealed metal-ceramic package
- Low distortion [Item: -51]  
 $IM_3 = -45\text{ dBc (TYP)} @ P_o = 31\text{ (dBm) S.C.L.}$
- Low thermal resistance  $R_{th(\text{ch-c})} \leq 1.6\text{ }^{\circ}\text{C/W}$

### APPLICATION

Item-01: 4.4~5.0 GHz band power amplifiers.

Item-51: Digital radio communication

### QUALITY GRADE

- IG

### ABSOLUTE MAXIMUM RATINGS ( $T_a = 25^{\circ}\text{C}$ )

Symbol	Parameter	Ratings	Unit
$V_{GDO}$	Gate to drain voltage	-15	V
$V_{GS0}$	Gate to source voltage	-15	V
$I_D$	Drain current	12	A
$I_{GR}$	Reverse gate current	-40	mA
$I_{GF}$	Forward gate current	+84	mA
$P_T$	Total power dissipation *1	93.7	W
$T_{ch}$	Channel temperature	175	$^{\circ}\text{C}$
$T_{stg}$	Storage temperature	-65~+175	$^{\circ}\text{C}$

\*1:  $T_c = 25^{\circ}\text{C}$

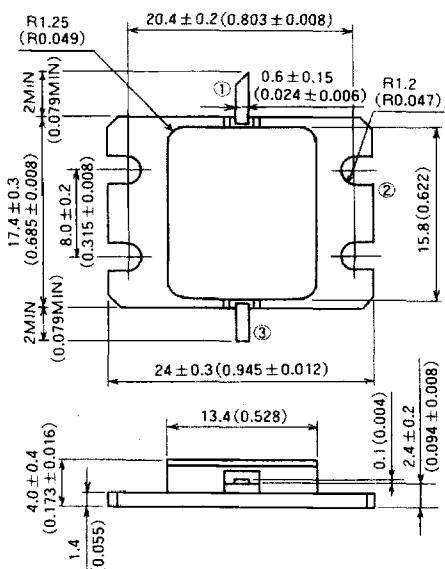
### ELECTRICAL CHARACTERISTICS ( $T_a = 25^{\circ}\text{C}$ )

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$I_{DSS}$	Saturated drain current	$V_{DS} = 3\text{V}, V_{GS} = 0\text{V}$	—	9	12	A
$g_m$	Transconductance	$V_{DS} = 3\text{V}, I_D = 4.4\text{A}$	—	4	—	S
$V_{GS(off)}$	Gate to source cut-off voltage	$V_{DS} = 3\text{V}, I_D = 80\text{mA}$	-2	-3	-4	V
$P_{1dB}$	Output power at 1dB gain compression	$V_{DS} = 10\text{V}, I_D = 4.5\text{A}, f = 3.7\text{~}4.2\text{GHz}$	41.5	42.5	—	dBm
$G_{LP}$	Linear power gain		8	9	—	dB
$I_D$	Drain current		—	4.5	—	A
$\eta_{add}$	Power added efficiency		—	33	—	%
$IM_3$	3rd order IM distortion *1		-42	-45	—	dBc
$R_{th(\text{ch-c})}$	Thermal resistance *2	$\Delta V_f$ method	—	—	1.6	$^{\circ}\text{C/W}$

\*1: Item-51, 2-tone test  $P_o = 31\text{dBm}$  Single Carrier Level  $f = 5.0\text{ MHz}$ ,  $\Delta f = 10\text{MHz}$ .

\*2: Channel to case

### OUTLINE DRAWING Unit: millimeters (inches)



GF-18

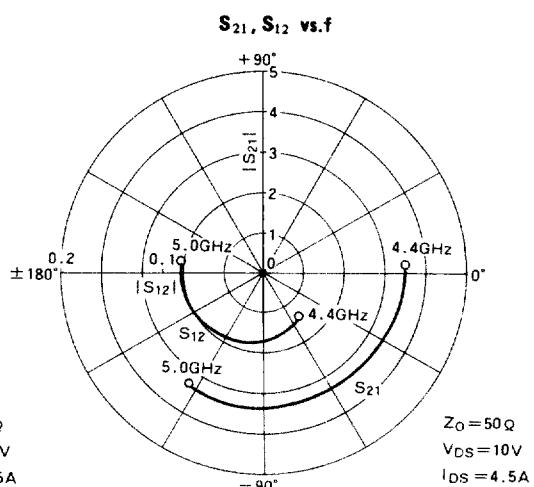
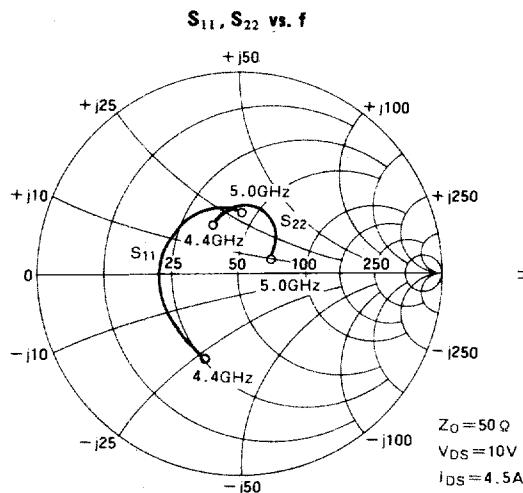
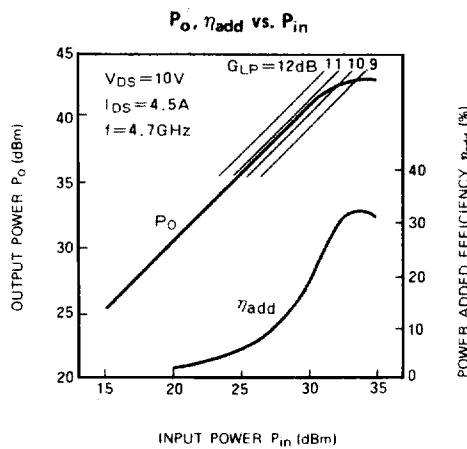
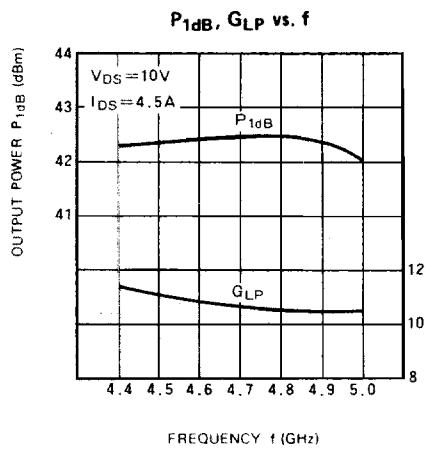
### RECOMMENDED BIAS CONDITIONS

- $V_{DS} = 10\text{V}$
- $I_D = 4.5\text{A}$
- $R_g = 25\Omega$
- Refer to Bias Procedure

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TYPICAL CHARACTERISTICS ( $T_a = 25^\circ\text{C}$ )**S PARAMETERS** ( $T_a = 25^\circ\text{C}$ ,  $V_{DS} = 10V$ ,  $I_{DS} = 4.5A$ )

f (GHz)	S Parameters (TYP.)							
	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
	Magn.	Angle (deg.)	Magn.	Angle (deg.)	Magn.	Angle (deg.)	Magn.	Angle (deg.)
4.4	0.46	-113	3.63	3	0.054	-49	0.31	121
4.5	0.41	-156	3.50	-20	0.063	-78	0.33	101
4.6	0.40	-179	3.45	-38	0.068	-93	0.33	90
4.7	0.38	154	3.42	-61	0.072	-123	0.33	79
4.8	0.37	135	3.38	-77	0.075	-140	0.31	71
4.9	0.33	109	3.34	-101	0.078	-167	0.25	51
5.0	0.29	89	3.27	-122	0.079	172	0.17	22